THAPAR INSTITUTE OF ENGINEERING AND TECHNOLOGY, PATIALA (Deemed-to-be University u/s 3 of the UGC Act, 1956)

December 12, 2017

Advertisement for the post of Research Associate (RA) in CSIR sponsored research project

Applications are invited for the post of **Research Associate** (**RA**) to work in CSIR sponsored project entitled, "Development and Realization of Accurate Temperature-Dependent Equivalent Circuit models for Multi Layer Graphene Nano Ribbon (MLGNR) Based VLSI Interconnects at Deep Submicron Technology Nodes".

Position & Salary			Essential qualifications			
Research 36,000/-	Associate,		Possessing Doctorate(PhD in Engineering) or equivalent or having 3 years of research, teaching			
			and design & development experience after M.E./M.Tech in ECE or VLSI Design			

The total duration of the project is three years.

The fellowship will be offered initially for a period of one year, which can be extended further, depending on the performance evaluation by the committee and will be coterminus with the duration of the project

- Candidates will be short listed for the interview based on merit and experience of the available candidates and decision of the selection committee will be final.
- The date and time of interview will be informed by email only.
- No TA/DA will be given to the candidates called for the interview.
- Applications complete in all respects should be sent to the Principal Investigator of the project at the following address or through email within 12 days from the advertisement.

For any further information/clarifications, the applicants may contact PI/Co-PI directly by email/telephone.

Dr.Mayank Kumar Rai **Assistant Professor**

Principal Investigator (P.I), ECED, Thapar Institute of Engg, and Tech, Patiala Email:mkrai@thapar.edu 8146158475

Dr. Rajesh Khanna Professor, ECED

Co-Principal Investigator ECED, Thapar Institute of Engg, and Tech. Patiala

Email: rkhanna@thapar.edu

APPLICATION FOR RESEARCH ASSOCIATE (RA) IN CSIR SPONSORED RESEARCH PROJECT

SUBJECT APP	LIED FOR:						
01. Name of Fe	ellowship : F	RA			Recent passport size		
02. Name in Bl	ock Letters	:	:				
03. Father's/ H	usband's Name	:			be affixed		
04. (a) Marital S	Status : Married/	Single:	(b) Nationality	······			
05. (a) Categ	ory : SC/ST/O	BC/PH/Gen:		(b) Date of E	Birth		
(c) AgeYrs	months						
06. Address for	r Communication	ı					
07. Contact De	tails: Phone:		: Mobile:				
Permanent Res	sidence						
E-mail ID:							
08. Educationa	l Qualifications (From SSC/Matric	c onwards. Attest	ted copies to be e	enclosed):		
Examination Passed	Subject (S)	University or Board	Month & Year of passing	Division or class	% of Marks		
09. Experience	<u> </u> :						
Name of the			Salary R		Reasons for		
organisation		Period of service			leaving		
with design.	From	to					
If yes give deta 11. Have you e 12. Any other in	ills (proof to be e ever been intervie nformation TION: I hereby d	nclosed) ewed in any CSIF	Examination: YE R Unit, if so give above furnished p		rrect and no		
Disco							
Place:			0 :				
Date:			Signature of the candidate				